



DGD2104M

HALF-BRIDGE GATE DRIVER IN SO-8

Description

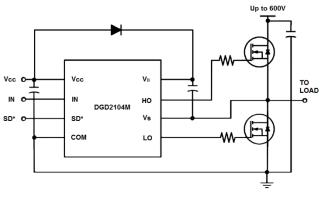
The DGD2104M is a high-voltage / high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD2104M's high side to switch to 600V in a bootstrap operation.

The DGD2104M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction.

The DGD2104M is offered in the SO-8 package and operates over an extended -40°C to +125°C temperature range.

Applications

- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers



Typical Configuration

Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 290mA Source / 600mA Sink Output Current Capability
- Designed for Enhanced Performance in Noisy Motor Applications
- Outputs Tolerant to Negative Transients
- Internal Dead Time to Protect MOSFETs
- Wide Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for V_{CC} (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SO-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.074 grams (Approximate)



Ordering Information (Note 4)

| Part Number | Marking | Reel Size (inch) | Tape Width (mm) | Quantity per Reel | |
|--|----------|------------------|-----------------|-------------------|--|
| DGD2104MS8-13 | DGD2104M | 13 | 12 | 2,500 | |
| Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. | | | | | |

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

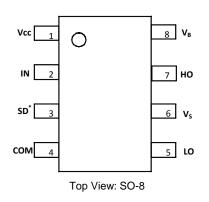
Marking Information



)'| = Manufacturer's Marking
 DGD2104M = Product Type Marking Code
 YY = Year (ex: 19 = 2019)
 WW = Week (01 to 53)



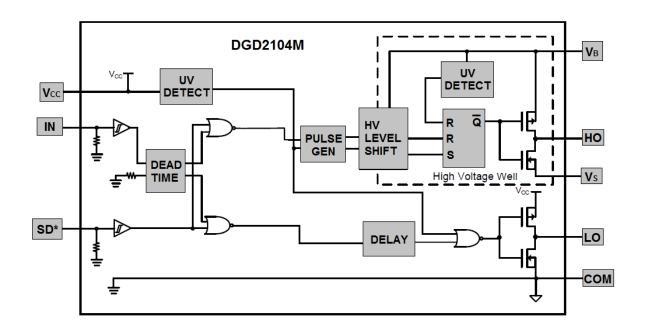
Pin Diagrams



Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|-----------------|--|
| 1 | V _{CC} | Logic and Low Side Supply |
| 2 | IN | Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO |
| 3 | SD* | Logic input for Shutdown, Enabled Low |
| 4 | COM | Low-Side and Logic Return |
| 5 | LO | Low-Side Gate Drive Output |
| 6 | Vs | High-Side Floating Supply Return |
| 7 | HO | High-Side Gate Drive Output |
| 8 | VB | High-Side Floating Supply |

Functional Block Diagram





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|----------------------|--|------|
| High-Side Floating Supply Voltage | VB | -0.3 to +624 | V |
| High-Side Floating Supply Offset Voltage | Vs | V _B -24 to V _B +0.3 | V |
| High-Side Floating Output Voltage | V _{HO} | V _S -0.3 to V _B +0.3 | V |
| Offset Supply Voltage Transient | dV _S / dt | 50 | V/ns |
| Low-Side Fixed Supply Voltage | V _{CC} | -0.3 to +24 | V |
| Low-Side Output Voltage | V _{LO} | -0.3 to V _{CC} +0.3 | V |
| Logic Input Voltage (IN and SD*) | V _{IN} | -0.3 to V _{CC} +0.3 | V |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Power Dissipation Linear Derating Factor (Note 5) | PD | 0.625 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 200 | °C/W |
| Operating Temperature | TJ | +150 | |
| Lead Temperature (Soldering, 10s) | TL | +300 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | |

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

| Parameter | Symbol | Min | Max | Unit |
|--|-----------------|---------------------|---------------------|------|
| High Side Floating Supply Absolute Voltage | VB | V _S + 10 | V _S + 20 | V |
| High Side Floating Supply Offset Voltage | Vs | (Note 6) | 600 | V |
| High Side Floating Output Voltage | V _{HO} | Vs | VB | V |
| Low Side Fixed Supply Voltage | Vcc | 10 | 20 | V |
| Low Side Output Voltage | V _{LO} | 0 | V _{CC} | V |
| Logic Input Voltage (IN and SD*) | V _{IN} | 0 | 5 | V |
| Ambient Temperature | T _A | -40 | +125 | °C |

Note: 6. Logic operation for Vs of -5V to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|---|--------------------|-----|------|-----|------|---|
| Logic "1" (IN) & Logic "0" (SD*) Input Voltage (Note 8) | VIH | 2.5 | - | _ | V | $V_{CC} = 10V$ to 20V |
| Logic "0" (IN) & Logic "1" (SD*) Input Voltage (Note 8) | VIL | _ | - | 0.8 | V | $V_{CC} = 10V$ to 20V |
| High Level Output Voltage, V _{BIAS} - V _O | V _{OH} | — | 0.05 | 0.2 | V | $I_0 = 2mA$ |
| Low Level Output Voltage, Vo | Vol | — | 0.02 | 0.1 | V | $I_0 = 2mA$ |
| Offset Supply Leakage Current | I _{LK} | — | - | 50 | μA | $V_B = V_S = 600V$ |
| Quiescent V _{BS} Supply Current | I _{BSQ} | — | 60 | 100 | μA | $V_{IN} = 0V \text{ or } 5V$ |
| Quiescent V _{CC} Supply Current | ICCQ1 | - | 350 | 500 | μA | $V_{IN} = 0V \text{ or } 5V, SD^* = 5V$ |
| Quiescent V _{CC} Supply Current in Shutdown | I _{CCQ2} | — | 590 | 750 | μA | $V_{IN} = 0V \text{ or } 5V, SD^* = 0V$ |
| Logic "1" Input Bias Current | I _{IN+} | — | 3.0 | 10 | μA | $V_{IN} = 5V, SD^* = 0V$ |
| Logic "0" Input Bias Current | I _{IN-} | — | - | 5.0 | μA | $V_{IN} = 0V, SD^* = 5V$ |
| V _{CC} Supply Undervoltage Positive Going Threshold | V _{CCUV+} | 8.0 | 8.9 | 9.8 | V | — |
| V _{CC} Supply Undervoltage Negative Going Threshold | Vccuv- | 7.4 | 8.2 | 9.0 | V | — |
| V _{BS} Supply Undervoltage Positive Going Threshold | V _{BSUV+} | 4.5 | 5.5 | 6.5 | V | — |
| V _{BS} Supply Undervoltage Negative Going Threshold | V _{BSUV-} | 4.2 | 5.2 | 6.2 | V | — |
| Output High Short Circuit Pulsed Current | I _{O+} | 130 | 290 | _ | mA | $V_0 = 0V$, PW $\leq 10\mu s$ |
| Output Low Short Circuit Pulsed Current | I _{O-} | 270 | 600 | _ | mA | V _O = 15V, PW ≤ 10µs |

Notes: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

8. For optimal operation, it is recommended that the input pulses (IN and SD*) should have an minimum amplitude of 2.5V with a minimum pulse width of 840ns.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|---|-----------------|-----|-----|-----|------|---------------------|
| Turn-On Propagation Delay | t _{ON} | _ | 680 | 820 | ns | $V_{\rm S} = 0V$ |
| Turn-Off Propagation Delay | toff | _ | 150 | 220 | ns | $V_{\rm S} = 600 V$ |
| Shutdown Propagation Delay | t _{SD} | _ | 160 | 220 | ns | - |
| Delay Matching, HO and LO Turn-On / Turn-Off | t _{DM} | — | - | 60 | ns | — |
| Turn-On Rise Time | t _R | _ | 70 | 170 | ns | $V_{\rm S} = 0V$ |
| Turn-Off Fall Time | t _F | _ | 35 | 90 | ns | $V_{\rm S} = 0V$ |
| Deadtime: t _{DT LO-HO} & t _{DT HO-LO} | t _{DT} | 300 | 420 | 650 | ns | - |



Timing Waveforms

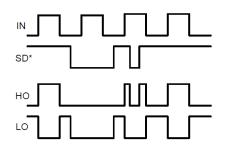


Figure 1. Input / Output Timing Diagram

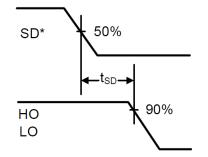
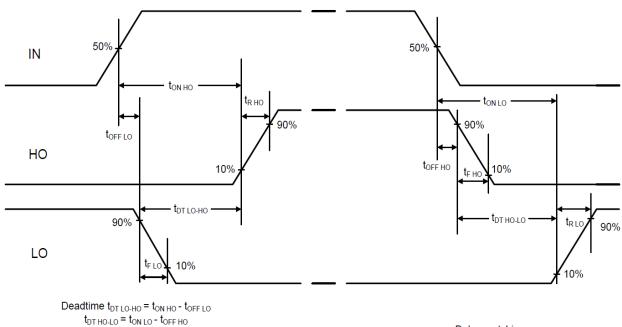
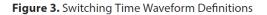


Figure 2. Shutdown Waveform Definition



Deadtime matching t_{MDT} = t_{DT LO-HO} - t_{DT HO-LO} $\begin{array}{l} \text{Delay matching} \\ t_{\text{DM OFF}} = t_{\text{OFF LO}} - t_{\text{OFF HO}} \\ t_{\text{DM ON}} = t_{\text{ON LO}} - t_{\text{ON HO}} \end{array}$





Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)

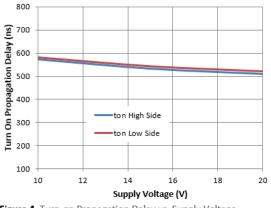


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

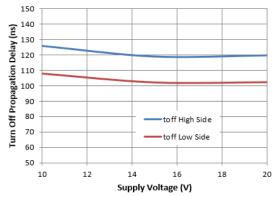
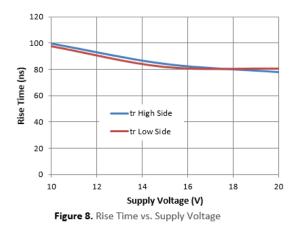


Figure 6. Turn-off Propagation Delay vs. Supply Voltage



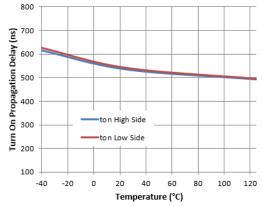


Figure 5. Turn-on Propagation Delay vs. Temperature

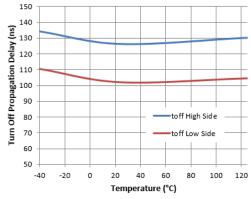
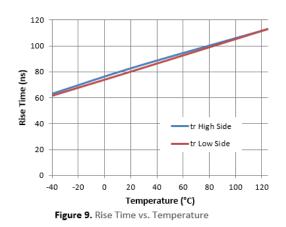
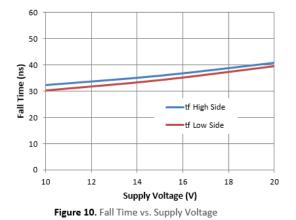


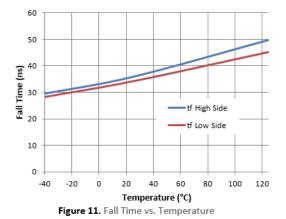
Figure 7. Turn-off Propagation Delay vs. Temperature





Typical Performance Characteristics (continued)





800 700 •ICC q IBSa 600 Quiescent Current (µA) 500 400 300 200 100 0 12 14 16 18 20 10 Supply Voltage (V)

Figure 12. Quiescent Current vs. Supply Voltage

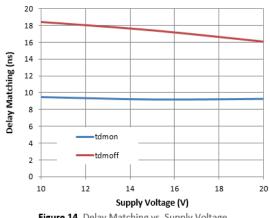
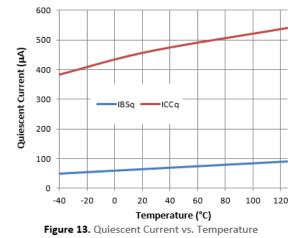


Figure 14. Delay Matching vs. Supply Voltage



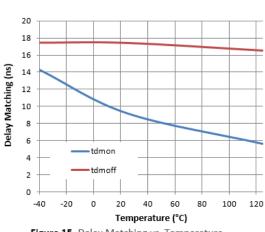
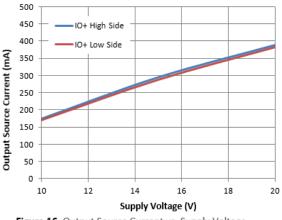


Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)



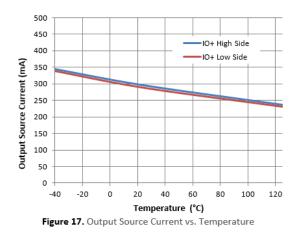
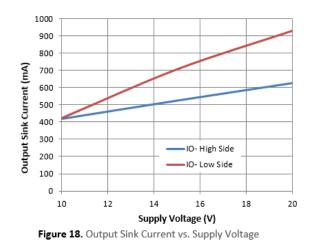
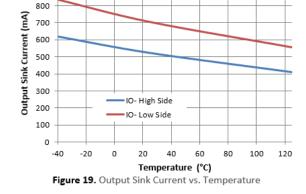


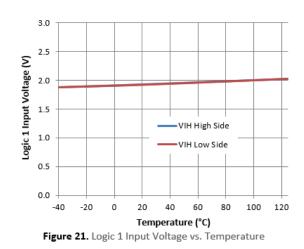
Figure 16. Output Source Current vs. Supply Voltage





1000

900



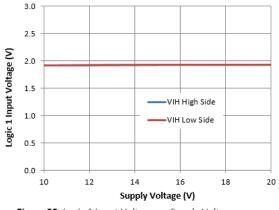
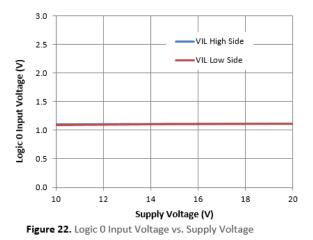


Figure 20. Logic 1 Input Voltage vs. Supply Voltage



Typical Performance Characteristics (continued)



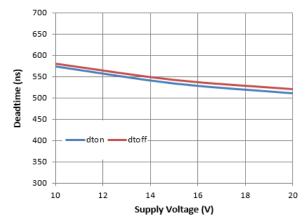
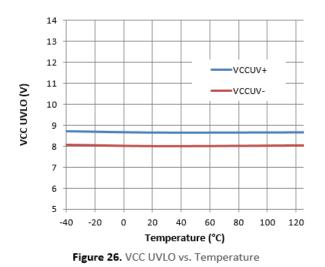


Figure 24. Deadtime vs. Supply Voltage



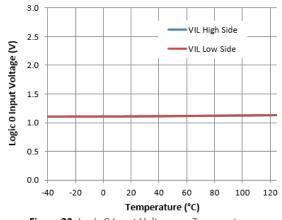


Figure 23. Logic 0 Input Voltage vs. Temperature

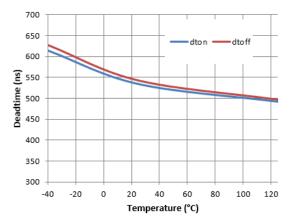


Figure 25. Deadtime vs. Temperature

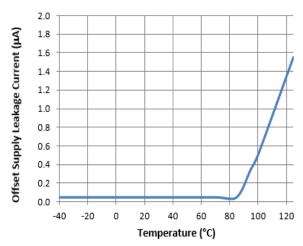


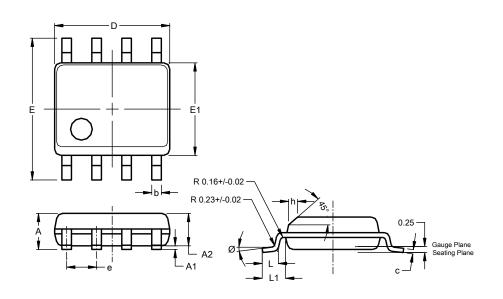
Figure 27. Offset Supply Leakage Current vs. Temperature



DGD2104M

Package Outline Dimensions

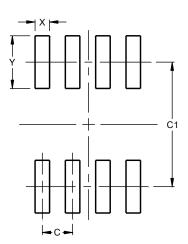
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SO-8 (Type TH) | | | | | | |
|----------------------|-------|-------|------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 1.35 | 1.75 | | | | |
| A1 | 0.10 | 0.25 | | | | |
| A2 | | | 1.45 | | | |
| b | 0.35 | 0.51 | | | | |
| С | 0.190 | 0.248 | | | | |
| D | 4.80 | 5.00 | 4.90 | | | |
| E | 5.80 | 6.20 | 6.00 | | | |
| E1 | 3.80 | 4.00 | 3.90 | | | |
| е | | | 1.27 | | | |
| h | 0.25 | 0.50 | | | | |
| L | 0.41 | 1.27 | | | | |
| L1 | | | 1.04 | | | |
| Ø | 0° | 8° | | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| c | 1.27 |
| C1 | 5.20 |

X

0.60

2.20

Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.

SO-8 (Type TH)

SO-8 (Type TH)



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